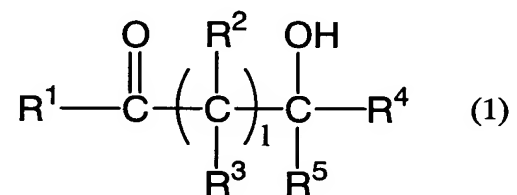


ABSTRACT OF THE DISCLOSURE

A photosensitive resin precursor composition exhibiting an excellent film thickness uniformity contains: a heat resistant resin precursor polymer; a radiation sensitive compound; and a solvent expressed by formula (1):



R<sup>1</sup> represents an alkyl group having a carbon number in the range of 1 to 3. R<sup>2</sup>, R<sup>3</sup>, R<sup>4</sup>, and R<sup>5</sup> each represent hydrogen or an alkyl group having a carbon number in the range of 1 to 3, and 1 represents an integer in the range of 0 to 3.